In re Appln. of KAMIYAMA et al. Application No. Unassigned

## ABSTRACT AMENDMENTS

Replace the Abstract with:

A semiconductor device having a gate electrode—7b formed on a silicon substrate—1 through via a gate insulating film is—constituted formed by laminating the gate insulating film with a silicon oxide film—4a, formed on the silicon substrate—1; an Hf silicate film—5a is formed on the silicon oxide film—4a; and a nitrogen-containing Hf silicate film—6a formed on the Hf silicate film—5a, and containing Hf in a peak concentration—of—1 in a range from one atomic %—or more and 30 to thirty atomic %—or less, and nitrogen in a peak concentration—of—10 in a range from ten atomic %—or more and 30 to thirty atomic %—or less.